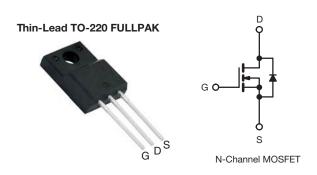
Vishay Siliconix

HALOGEN FREE

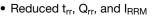
E Series Power MOSFET with Fast Body Diode and Low Gate Charge



PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	650)
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.127
Q _g max. (nC)	75	
Q _{gs} (nC)	17	
Q _{gd} (nC)	19	
Configuration	Sing	le

FEATURES

- Reduced figure-of-merit (FOM): R_{on} x Q_q
- Fast body diode MOSFET using E series technology



- Increased robustness due to low Q_{rr}
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Computing
 - ATX power supplies
- Industrial
 - Welding
 - Induction heating
 - Battery chargers
 - Uninterruptible power supplies (UPS)
- Renewable energy
 - String PV inverters

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA25N60EFL-E3			
Lead (Pb)-free and halogen-free	SiHA25N60EFL-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V_{DS}	600	V	
Gate-source voltage	V_{GS}	± 30	V		
Continuous drain current (T _J = 150 °C) ^e	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D	25		
	$T_C = 100 ^{\circ}C$		16	Α	
Pulsed drain current ^a	I _{DM}	61			
Linear derating factor			2	W/°C	
Single pulse avalanche energy b		E _{AS}	353	mJ	
Maximum power dissipation		P_D	39	W	
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	$V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$	dV/dt	70	V/ns	
Reverse diode dV/dt ^d	αν/αι	15	V/IIS		
Soldering recommendations (peak temperature) ^c	for 10 s		300	°C	
Mounting torque	M3 screw		0.6	Nm	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_q = 25 \,\Omega$, $I_{AS} = 5 \,\text{A}$
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$
- e. Limited by maximum junction



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THERMAL RESISTANCE RATING	is			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	3.2	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.69	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Cata assuma laskaga		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I_{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zoro goto voltago droin ourrent	1	V _{DS} =	= 480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 12.5 A$	-	0.127	0.146	Ω
Forward transconductance	9 _{fs}	V _{DS} =	= 30 V, I _D = 12.5 A	-	11.3	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2274	-	
Output capacitance	C _{oss}	7	$V_{DS} = 100 \text{ V},$		137	-	•
Reverse transfer capacitance	C_{rss}		f = 1 MHz	-	4	-	_
Effective output capacitance, energy related ^a	$C_{o(er)}$	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	79	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	330	-	
Total gate charge	Qg			-	50	75	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 12.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	17	-	nC
Gate-drain charge	Q _{gd}	7		-	19	-	
Turn-on delay time	t _{d(on)}			-	25	50	
Rise time	t _r	V _{DD} = 480 V, I _D = 12.5 A,		-	39	68	
Turn-off delay time	t _{d(off)}	$R_g = 1$	9.1 Ω , $V_{GS} = 10 \text{ V}$	-	47	94	ns
Fall time	t _f	1		-	21	42	1
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET syml	MOSFET symbol showing the		-	25	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	61	- A
Diode forward voltage	V _{SD}	T _J = 25 °C	$T_J = 25 ^{\circ}\text{C}, I_S = 12.5 \text{A}, V_{GS} = 0 \text{V}$		0.9	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12.5 \text{ A},$ $dI/dt = 100 \text{ A/µs}, V_R = 25 \text{ V}$		-	138	276	ns
Reverse recovery charge	Q _{rr}			-	0.8	1.6	μC
Reverse recovery current	I _{RRM}			-	11	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

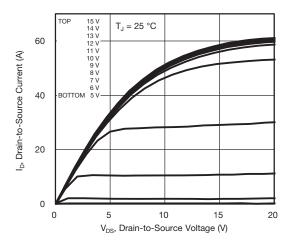


Fig. 1 - Typical Output Characteristics

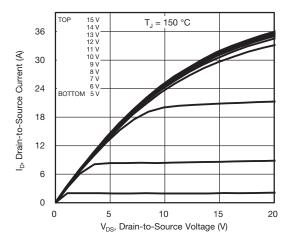


Fig. 2 - Typical Output Characteristics

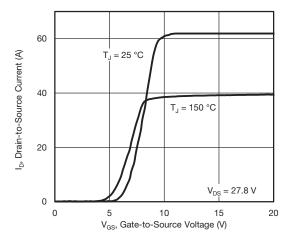


Fig. 3 - Typical Transfer Characteristics

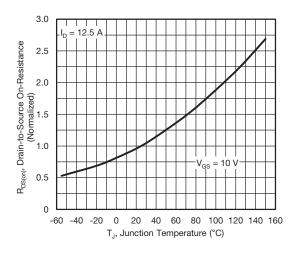


Fig. 4 - Normalized On-Resistance vs. Temperature

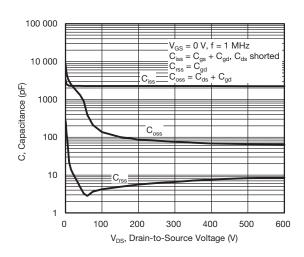


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

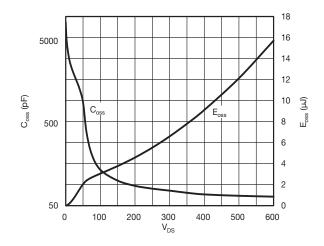


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}



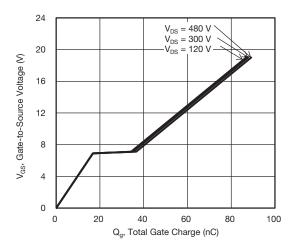


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

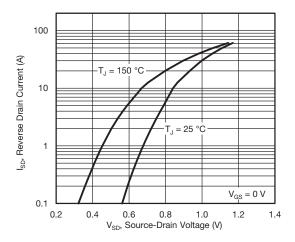


Fig. 8 - Typical Source-Drain Diode Forward Voltage

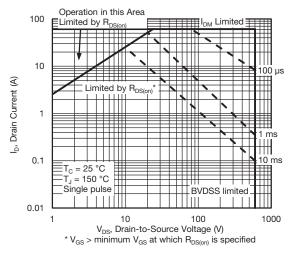


Fig. 9 - Maximum Safe Operating Area

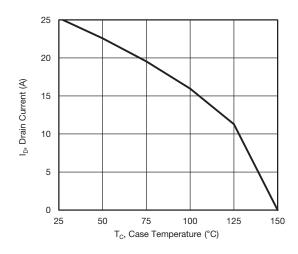


Fig. 10 - Maximum Drain Current vs. Case Temperature

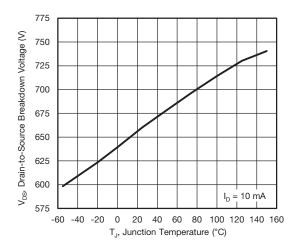


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



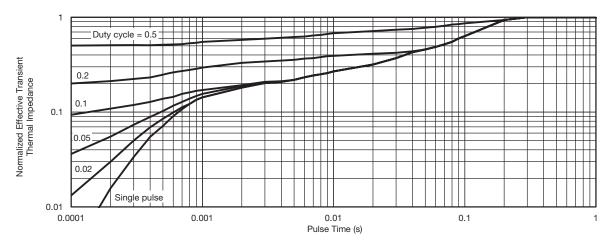


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

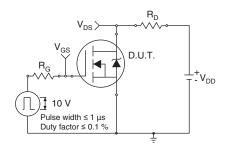


Fig. 13 - Switching Time Test Circuit

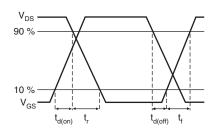


Fig. 14 - Switching Time Waveforms

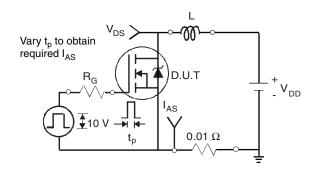


Fig. 15 - Unclamped Inductive Test Circuit

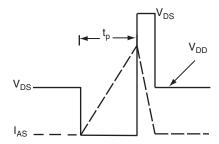


Fig. 16 - Unclamped Inductive Waveforms

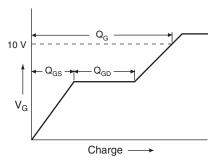


Fig. 17 - Basic Gate Charge Waveform

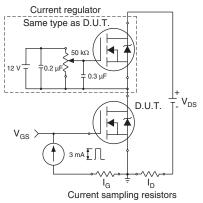
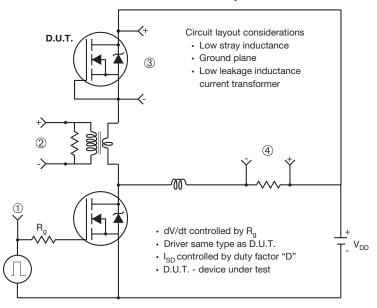


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



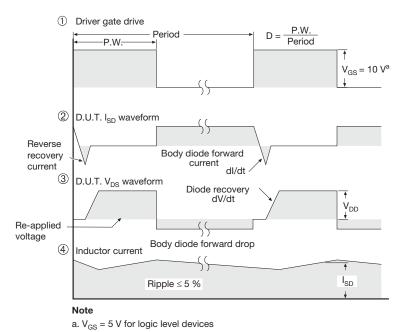


Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





SYMBOL		DIMEN	ISIONS	
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	=	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
Е	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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